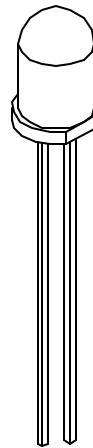
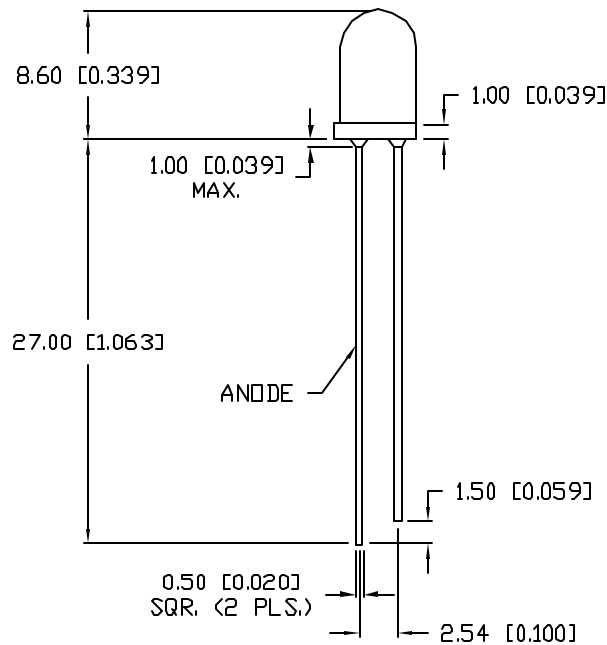
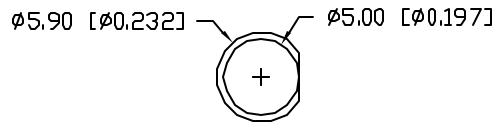


UNCONTROLLED DOCUMENT

PART NUMBER
SSL-LX5093SRC/X

REV.
D



REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	UPDATED SPECS.	1.5.95
B	E.C.N. #10251.	9.30.96
C	E.C.N. #10BRDR. & REDRAWN IN 3D.	5.31.01
D	E.C.N. #10788.	9.13.01

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		660		nm	
FORWARD VOLTAGE		1.7	2.2	V_f	
REVERSE VOLTAGE	4.0			V_r	$I_f=100\mu\text{A}$
AXIAL INTENSITY /DU	1000	1200		mcd	$I_f=20\text{mA}$
/DV	1300	1500		mcd	$I_f=20\text{mA}$
/DW	1600	1800		mcd	$I_f=20\text{mA}$
/E	2000	2800		mcd	$I_f=20\text{mA}$
/F	3500	4000		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		30		2x theta	
EMITTED COLOR:	RED				
EPOXY LENS FINISH:	WATER CLEAR				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	100	mW
DERATE FROM 25°C	-1.2	mW/ $^\circ\text{C}$
OPERATING, STORAGE TEMP.	-40 TO +85	$^\circ\text{C}$
SOLDERING TEMP.	+260	$^\circ\text{C}$
2.0mm FROM BODY		3 SEC. MAX

* $t < 10\mu\text{s}$

REPLACES PART #: SSL-LX5093SRC(/B-/E)

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X= ± 1 (± 0.039), XX= ± 0.5 (± 0.020), XXX= ± 0.25 (± 0.010), XXXX= ± 0.127 (± 0.005). LEAD SIZE= ± 0.05 (± 0.002), LEAD LENGTH= ± 0.75 (± 0.030), MIN=^{+0.00}/_{-0.00} DECIMAL PRECISION, MAX.=^{+0.00}/_{-0.00} DECIMAL PRECISION

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REV.	PART NUMBER
D	SSL-LX5093SRC/X

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T-5mm (T-1 3/4) 660nm SUPER RED LED,
WATER CLEAR LENS.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY:	CHECKED BY:	APPROVED BY:	DATE:
BC			2.9.93
			PAGE: 1 OF 1
			SCALE: N/A